SDM03U40

SOD-523

Min

1.50

1.10

0.25

0.70

0.10

0.55

All Dimensions in mm

Max

1.70

1.30

0.35

0.90

0.20

0.65

Dim

Α

в

С

D

E

G

SURFACE MOUNT SCHOTTKY BARRIER DIODE

CATHODE MARK

E

Features

- Low Forward Voltage Drop
- Guard Ring Die Construction for
- Transient Protection
- Ideal for low logic level applications
- Low Capacitance
- Lead Free by Design/RoHS Compliant (Note 1)
- "Green" Device, Note 4 and 5
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOD-523
- Case Material: Molded Plastic, "Green" Molding Compound, Note 5. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin annealed over Alloy 42
 leadframe. Solderable per MIL-STD-202, Method 208
- Marking Code: LK
- Ordering Information: See Last Page
- Weight: 0.002 grams (approximate)

Maximum Ratings @ T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit	
Peak Reverse Voltage	V _{RM}	40	V	
DC Reverse Voltage	V _R	30	V	
RMS Reverse Voltage	V _{R(RMS)}	21	V	
Average Rectified Current	lo	30	mA	
Non-Repetitive Peak Forward Surge Current @8.3ms Single half sine-wave superimposed on rated load	I _{FSM}	200	mA	

< □

<C>

MARKING CODE

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 2)	Pd	150	mW
Thermal Resistance, Junction to Ambient (Note 2)	R _{0JA}	667	°C/W
Operating and Storage Temperature Range	Tj, Tstg	-40 to +125	°C

Electrical Characteristics @ T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Мах	Unit	Test Conditions
Reverse Breakdown Voltage (Note 3)	V _{(BR)R}	40			V	I _R = 10uA
Forward Voltage	VF		290	370	mV	I _F = 1mA
Peak Reverse Current (Note 3)	IR			0.5	μA	V _R = 30V
Total Capacitance	Ст	—	2	—	pF	$V_{R} = 1V, f = 1.0 \text{ MHz}$

1. No purposefully added lead.

Note:

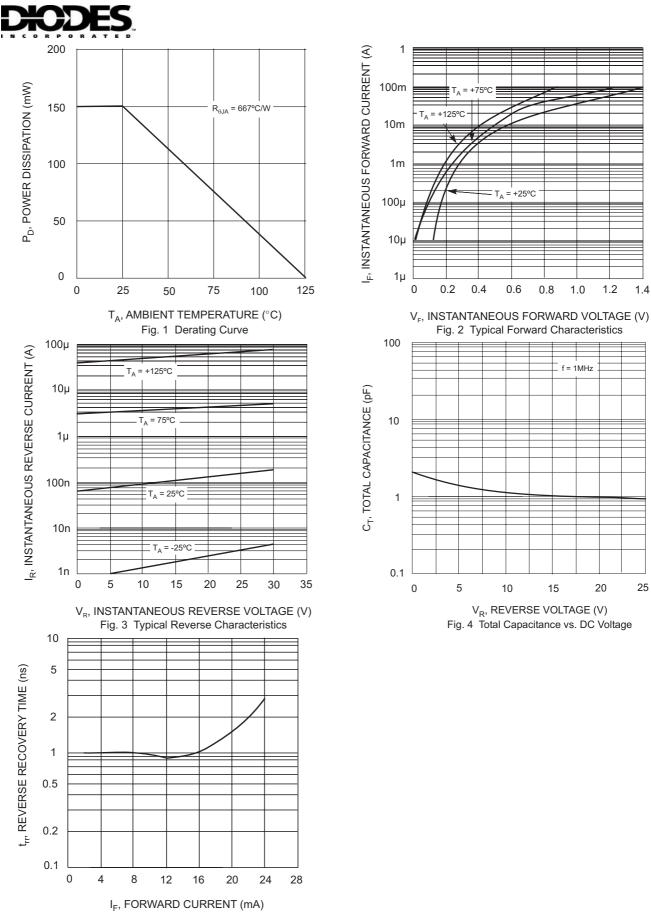
at http://www.diodes.com/datasheets/ap02001.pdf. T_A = 25°C.

Short duration pulse test used to minimize self-heating effect.

Diodes Inc.'s "Green" Policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

5. Product manufactured with date code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to date code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

^{2.} Part mounted on FR-4 board with recommended pad layout, which can be found on our website



0.8

1.0

f = 1MHz

20

15

25

1.2

1.4

Fig. 5 Typical Reverse Recovery Time Characteristics



Ordering Information (Note 5 & 6)

Device	Packaging	Shipping
SDM03U40-7	SOD-523	3000/Tape & Reel
SDM03U40-76K	SOD-523	6000/Tape & Reel

Note: 5. Product manufactured with date code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to date code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

6. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

IMPORTANT NOTICE

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. Diodes Incorporated does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on our website, harmless against all damages.

LIFE SUPPORT

Diodes Incorporated products are not authorized for use as critical components in life support devices or systems without the expressed written approval of the President of Diodes Incorporated.